

SERIES 24 AND 28 STANDARD AND LOW POWER PROGRAMMABLE READ-ONLY MEMORIES

SEPTEMBER 1979—REVISED AUGUST 1984

- Expanded Family of Standard and Low Power PROMs
- Titanium-Tungsten (Ti-W) Fuse Links for Reliable Low-Voltage Full-Family-Compatible Programming
- Full Decoding and Fast Chip Select Simplify System Design
- P-N-P Inputs for Reduced Loading On System Buffers/Drivers
- Each PROM Supplied With a High Logic Level Stored at Each Bit Location
- Applications Include:
 - Microprogramming/Firmware Loaders
 - Code Converters/Character Generators
 - Translators/Emulators
 - Address Mapping/Look-Up Tables

description

The 24 and 28 Series of monolithic TTL programmable read-only memories (PROMs) feature an expanded selection of standard and low-power PROMs. This expanded PROM family provides the system designer with considerable flexibility in upgrading existing designs or optimizing new designs. Featuring proven titanium-tungsten (Ti-W) fuse links with low-current MOS-compatible p-n-p inputs, all family members utilize a common programming technique designed to program each link with a 20-microsecond pulse.

The 4096-bit and 8192-bit PROMs are offered in a wide variety of packages ranging from 18-pin 300 mil-wide thru 24 pin 600 mil-wide. The 16,384-bit PROMs provide twice the bit density of the 8192-bit PROMs and are provided in a 24 pin 600 mil-wide package.

All PROMs are supplied with a logic-high output level stored at each bit location. The programming procedure will produce open-circuits in the Ti-W metal links, which reverses the stored logic level at the selected location. The procedure is irreversible; once altered, the output for that bit location is permanently programmed. Outputs that have never been altered may later be programmed to supply the opposite output level. Operation of the unit within the recommended operating conditions will not alter the memory content.

Active level(s) at the chip-select input(s) (S or \bar{S}) enables all of the outputs. An inactive level at any chip-select input causes all outputs to be in the three-state, or off condition.

standard PROMs

The standard PROM members of Series 24 and 28 offer high performance for applications which require the uncompromised speed of Schottky technology. The fast chip-select access times allow additional decoding delays to occur without degrading speed performance.

| TYPE NUMBER | PACKAGE [†] AND TEMPERATURE RANGE DESIGNATORS | OUTPUT CONFIGURATION [‡] | BIT SIZE (ORGANIZATION) | TYPICAL PERFORMANCE | | |
|-------------|--|-----------------------------------|-----------------------------|---------------------|--------|-------------------|
| | | | | ACCESS TIMES | | POWER DISSIPATION |
| | | | | ADDRESS | SELECT | |
| TBP24S10 | MJ, J, N | ▽ | 1024 Bits (256W × 4B) | 35 ns | 20 ns | 375 mW |
| TBP24SA10 | MJ, J, N | ◊ | | | | |
| TBP28S42 | MJ, J, N | ▽ | 4096 Bits (512W × 8B) | 35 ns | 20 ns | 500 mW |
| TBP28SA42 | MJ, J, N | ◊ | | | | |
| TBP28S46 | MJW, JW, NW | ▽ | | | | |
| TBP28SA46 | MJW, JW, NW | ◊ | | | | |
| TBP24S41 | MJ, J, N | ▽ | 4096 Bits (1024 × 4B) | 40 ns | 20 ns | 475 mW |
| TBP24SA41 | MJ, J, N | ◊ | 8192 Bits (2048 × 4B) | 45 ns | 20 ns | 625 mW |
| TBP24S81 | MJ, J, N | ▽ | | | | |
| TBP24SA81 | MJ, J, N | ◊ | 8192 Bits (1024 × 8B) | 45 ns | 20 ns | 625 mW |
| TBP28S86A | MJW, JW, NW | ▽ | | | | |
| TBP28SA86A | MJW, JW, NW | ◊ | | | | |
| TBP28S2708A | NW | ▽ | | | | |
| TBP28S166 | NW | ▽ | 16,384 Bits (2048W × 8B) | 35 ns | 15 ns | 650 mW |

[†]MJ and MJW designates full-temperature-range circuits (formerly 54 Family), J, JW, N, and NW designates commercial-temperature-range circuits (formerly 74 Family).

[‡]▽ = three state, ◊ = open collector.

4

PROMS

SERIES 24 AND 28 STANDARD AND LOW-POWER PROGRAMMABLE READ-ONLY MEMORIES

low power PROMs

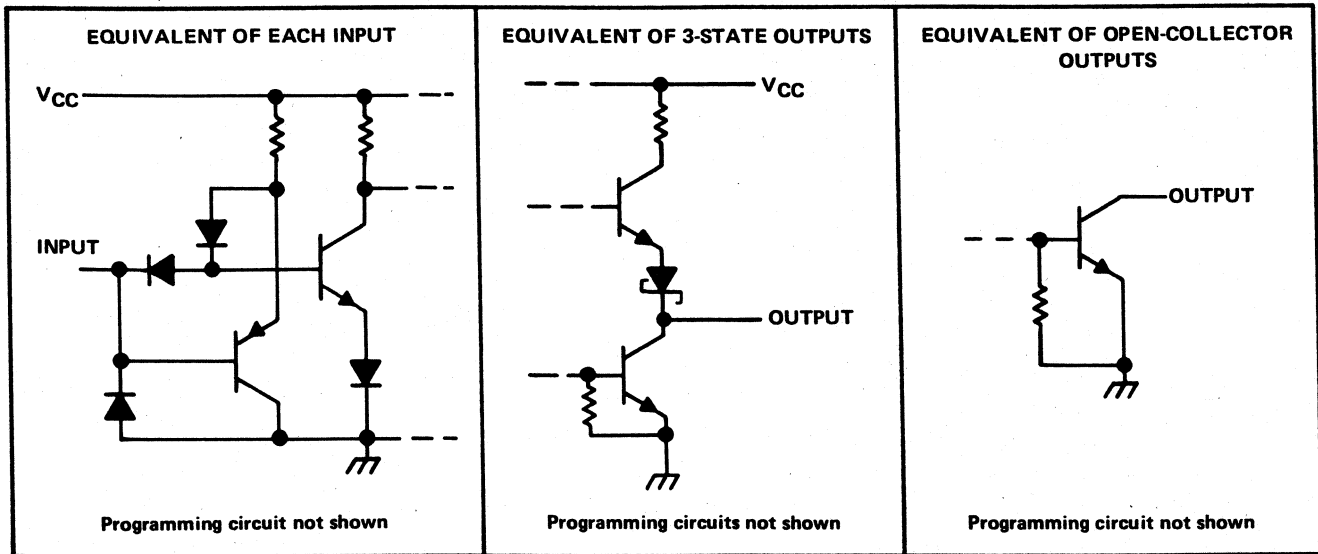
To upgrade systems utilizing MOS EPROMs or MOS PROMs, or when designing new systems which do not require maximum speed, the low-power PROM family offers the output drive and speed performance of bipolar technology, plus reduced power dissipation.

| TYPE NUMBER | PACKAGE [†] AND TEMPERATURE RANGE DESIGNATORS | OUTPUT CONFIGURATION [‡] | BIT SIZE (ORGANIZATION) | TYPICAL PERFORMANCE | | |
|-------------|--|-----------------------------------|-----------------------------|---------------------|--------|-------------------|
| | | | | ACCESS TIMES | | POWER DISSIPATION |
| | | | | ADDRESS | SELECT | |
| TBP28L22 | MJ, J, N | ▽ | 2048 Bits (256W × 8B) | 45 ns | 20 ns | 375 mW |
| TBP28LA22 | MJ, J, N | ◊ | | | | |
| TBP28L42 | MJ, J, N | ▽ | 4096 Bits (512W × 8B) | 60 ns | 30 ns | 250 mW |
| TBP28L46 | MJW, JW, NW | ▽ | | | | |
| TBP28L86A | MJW, JW, NW | ▽ | 8192 Bits (1024W × 8B) | 80 ns | 35 ns | 350 mW |
| TBP28L166 | NW | ▽ | 16,384 Bits (2084W × 8B) | 65 ns | 30 ns | 350 mW |

[†] MJ and MJW designates full-temperature-range circuits (formerly 54 Family), J, JW, N, and NW designates commercial-temperature-range circuits (formerly 74 Family).

[‡] ▽ = three state, ◊ = open collector.

schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| | |
|--|----------------|
| Supply voltage (see Note 1) | 7 V |
| Input voltage | 5.5 V |
| Chip-select peak input voltage (S, S1, S2) (see Note 2) | 11 V |
| Off-state output voltage | 5.5 V |
| Off-state peak output voltage (see Note 2) | 16.25 V |
| Operating free-air temperature range: Full-temperature-range circuits (M suffix) | -55°C to 125°C |
| Commercial-temperature-range circuits | 0°C to 70°C |
| Storage temperature range | -65°C to 150°C |

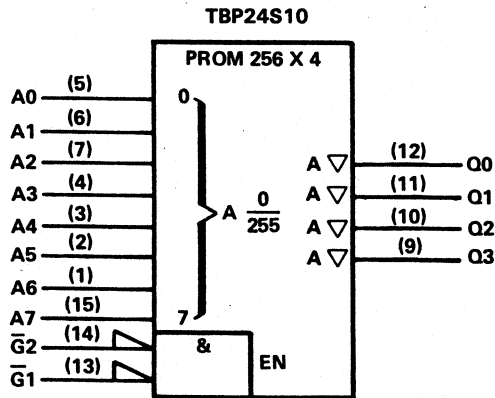
NOTES: 1. Voltage values are with respect to network ground terminal.

2. These ratings apply only under the conditions described in the programming procedure.

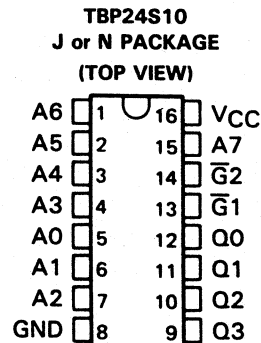
TBP24S10
1024 BIT (256 WORDS BY 4 BITS)

STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

logic symbol



pin assignment



recommended operating conditions

| PARAMETER | MJ | | | J OR N | | | UNIT |
|---|-----|-----|-----|--------|-----|------|------|
| | MIN | NOM | MAX | MIN | NOM | MAX | |
| V _{CC} Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| V _{IH} High-level input voltage | 2 | | | 2 | | | V |
| V _{IL} Low-level input voltage | | | 0.8 | | | 0.8 | V |
| I _{OH} High-level output current | | | -2 | | | -6.5 | mA |
| I _{OL} Low-level output current | | | 16 | | | 16 | mA |
| T _A Operating free-air temperature range | -55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS † | MJ | | | J OR N | | | UNIT |
|------------------------------|--|-----|------|-------|--------|------|-------|------|
| | | MIN | TYP‡ | MAX | MIN | TYP‡ | MAX | |
| V _{IK} | V _{CC} = MIN, I _I = -18 mA | | | -1.2 | | | -1.2 | V |
| V _{OH} | V _{CC} = MIN, I _{OH} = MAX | 2.4 | 3.1 | | 2.4 | 3.1 | | V |
| V _{OL} | V _{CC} = MIN, I _{OL} = 16 mA | | | 0.5 | | | 0.5 | V |
| I _{OZH} | V _{CC} = MAX, V _O = 2.4 V | | | 50 | | | 50 | μA |
| I _{OZL} | V _{CC} = MAX, V _O = 0.5 V | | | -50 | | | -50 | μA |
| I _I | V _{CC} = MAX, V _I = 5.5 V | | | 1 | | | 1 | mA |
| I _{IH} | V _{CC} = MAX, V _I = 2.7 V | | | 25 | | | 25 | μA |
| I _{IL} | V _{CC} = MAX, V _I = 0.5 V | | | -0.25 | | | -0.25 | mA |
| I _{OS} [§] | V _{CC} = MAX | -30 | | -100 | -30 | | -100 | mA |
| I _{CC} | V _{CC} = MAX | | 75 | 100 | | 75 | 100 | mA |

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MJ | | | J OR N | | | UNIT |
|--|-------------------------------------|-----|------|-----|--------|------|-----|------|
| | | MIN | TYP‡ | MAX | MIN | TYP‡ | MAX | |
| t _{a(A)} Access time from address | C _L = 30 pF | | 35 | 75 | | 35 | 55 | ns |
| t _{a(S)} Access time from chip select (enable time) | See Note 3 | | 20 | 40 | | 20 | 35 | ns |
| t _{dis} Disable time | C _L = 5 pF See Note 3 | | 15 | 40 | | 15 | 35 | ns |

†For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

‡All typical values are at V_{CC} = 5 V, T_A = 25 °C.

§Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

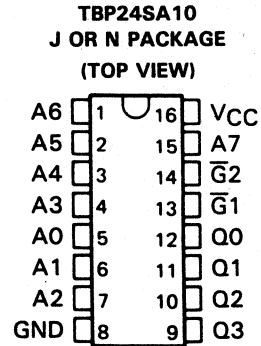
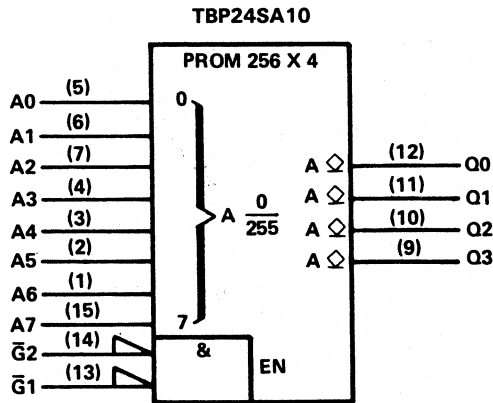
4

PROMS

TBP24SA10
1024 BITS (256 WORDS BY 4 BITS)
STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH OPEN-COLLECTOR OUTPUTS

logic symbol

pin assignment



recommended operating conditions

| PARAMETER | | MJ | | | J OR N | | | UNIT |
|-----------------|--------------------------------------|-----|-----|-----|--------|-----|------|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | |
| V _{CC} | Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| V _{IH} | High-level input voltage | 2 | | | 2 | | | V |
| V _{IL} | Low-level input voltage | | | 0.8 | | | 0.8 | V |
| V _{OH} | High-level output voltage | | | 5.5 | | | 5.5 | V |
| I _{OL} | Low-level output current | | | 16 | | | 16 | mA |
| T _A | Operating free-air temperature range | -55 | | 125 | 0 | | 70 | °C |

4

PROMS

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS [†] | MJ | | | J OR N | | | UNIT |
|-----------------|--|-----|------------------|-------|--------|------------------|-------|------|
| | | MIN | TYP [‡] | MAX | MIN | TYP [‡] | MAX | |
| V _{IK} | V _{CC} = MIN, I _I = -18 mA | | | -1.2 | | | -1.2 | V |
| I _{OH} | V _{CC} = MIN, V _{OH} = 2.4 V | | | 0.05 | | | 0.05 | mA |
| | | | | 0.1 | | | 0.1 | |
| V _{OL} | V _{CC} = MIN, I _{OL} = 16 mA | | | 0.5 | | | 0.45 | V |
| I _I | V _{CC} = MAX, V _I = 5.5 V | | | 1 | | | 1 | mA |
| I _{IH} | V _{CC} = MAX, V _I = 2.7 V | | | 25 | | | 25 | μA |
| I _{IL} | V _{CC} = MAX, V _I = 0.5 V | | | -0.25 | | | -0.25 | mA |
| I _{CC} | V _{CC} = MAX | 75 | 100 | | 75 | 100 | | mA |

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MJ | | | J OR N | | | UNIT | |
|-------------------|--|-----|------------------|-----|--------|------------------|-----|------|----|
| | | MIN | TYP [‡] | MAX | MIN | TYP [‡] | MAX | | |
| t _{a(A)} | Access time from address | | | 35 | 75 | | 35 | 65 | ns |
| t _{a(S)} | Access time from chip select (enable time) | | | 20 | 40 | | 20 | 35 | ns |
| t _{PLH} | Propagation delay time low-to-high-level output from chip select | | | 15 | 40 | | 20 | 35 | ns |

[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

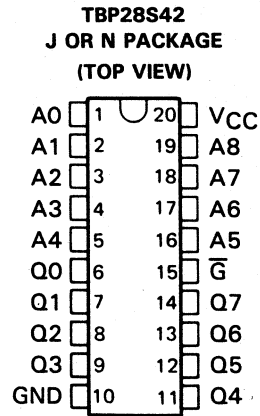
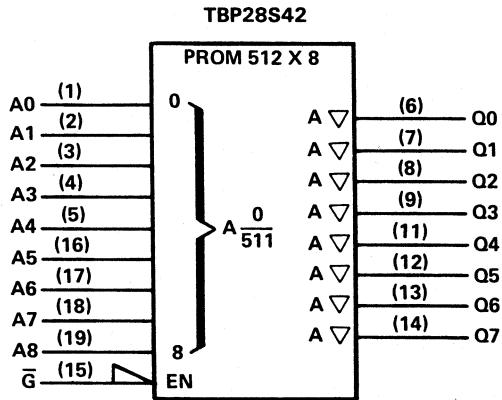
[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

TBP28S42
4096 BITS (512 WORDS BY 8 BITS)
STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

logic symbol

pin assignment



recommended operating conditions

| PARAMETER | DESCRIPTION | MJ | | | J OR N | | | UNIT |
|-----------------|--------------------------------------|-----|-----|-----|--------|-----|------|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | |
| V _{CC} | Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| V _{IH} | High-level input voltage | 2 | | | 2 | | | V |
| V _{IL} | Low-level input voltage | | | 0.8 | | | 0.8 | V |
| I _{OH} | High-level output current | | | -2 | | | -6.5 | mA |
| I _{OL} | Low-level output current | | | 16 | | | 16 | mA |
| T _A | Operating free-air temperature range | -55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS [†] | MJ | | | J OR N | | | UNIT |
|------------------------------|--|-----|------------------|-------|--------|------------------|-------|------|
| | | MIN | TYP [‡] | MAX | MIN | TYP [‡] | MAX | |
| V _{IK} | V _{CC} = MIN, I _I = -18 mA | | | -1.2 | | | -1.2 | V |
| V _{OH} | V _{CC} = MIN, I _{OH} = MAX | 2.4 | 3.1 | | 2.4 | 3.1 | | V |
| V _{OL} | V _{CC} = MIN, I _{OL} = 16 mA | | | 0.5 | | | 0.5 | V |
| I _{OZH} | V _{CC} = MAX, V _O = 2.4 V | | | 50 | | | 50 | μA |
| I _{OZL} | V _{CC} = MAX, V _O = 0.5 V | | | -50 | | | -50 | μA |
| I _I | V _{CC} = MAX, V _I = 5.5 V | | | 1 | | | 1 | mA |
| I _{IH} | V _{CC} = MAX, V _I = 2.7 V | | | 25 | | | 25 | μA |
| I _{IL} | V _{CC} = MAX, V _I = 0.5 V | | | -0.25 | | | -0.25 | mA |
| I _{OS} [§] | V _{CC} = MAX | -30 | | -100 | -30 | | -100 | mA |
| I _{CC} | V _{CC} = MAX | | 100 | 135 | | 100 | 135 | mA |

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MJ | | | J OR N | | | UNIT |
|-------------------|--|-----|------------------|-----|--------|------------------|-----|------|
| | | MIN | TYP [‡] | MAX | MIN | TYP [‡] | MAX | |
| t _{a(A)} | Access time from address | | 35 | 70 | | 35 | 60 | ns |
| t _{a(S)} | Access time from chip select (enable time) | | 20 | 45 | | 20 | 45 | ns |
| t _{dis} | Disable time | | 15 | 45 | | 15 | 40 | ns |

[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25 °C.

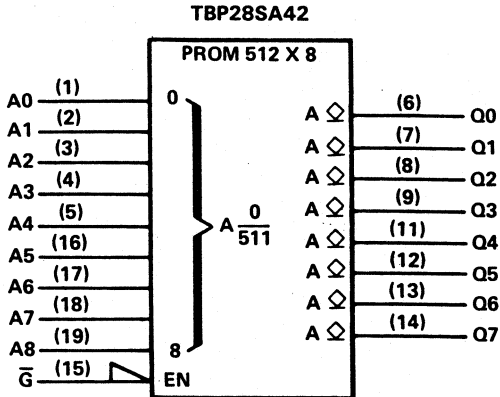
[§]Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

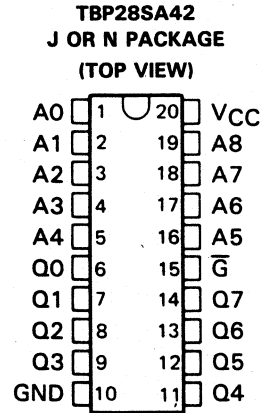
4 PROMS

TBP28SA42
4096 BITS (512 WORDS BY 8 BITS)
STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH OPEN-COLLECTOR OUTPUTS

logic symbol



pin assignment



recommended operating conditions

| PARAMETER | MJ | | | J OR N | | | UNIT |
|---|-----|-----|-----|--------|-----|------|---------|
| | MIN | NOM | MAX | MIN | NOM | MAX | |
| V _{CC} Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| V _{IH} High-level input voltage | 2 | | | 2 | | | V |
| V _{IL} Low-level input voltage | 0.8 | | | 0.8 | | | V |
| V _{OH} High-level output voltage | 5.5 | | | 5.5 | | | V |
| I _{OL} Low-level output current | 16 | | | 16 | | | mA |
| T _A Operating free-air temperature range | -55 | | | 125 | | | 0 70 °C |

4

PROMS

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS† | MJ | | | J OR N | | | UNIT |
|-----------------|--|-------|------|-----|--------|------|-----|------|
| | | MIN | TYP‡ | MAX | MIN | TYP‡ | MAX | |
| V _{IK} | V _{CC} = MIN, I _I = -18 mA | -1.2 | | | -1.2 | | | V |
| I _{OH} | V _{CC} = MIN, V _{OH} = 2.4 V | 0.05 | | | 0.05 | | | mA |
| | | 0.1 | | | 0.1 | | | |
| V _{OL} | V _{CC} = MIN, I _{OL} = 16 mA | 0.5 | | | 0.5 | | | V |
| I _I | V _{CC} = MAX, V _I = 5.5 V | 1 | | | 1 | | | mA |
| I _{IH} | V _{CC} = MAX, V _I = 2.7 V | 25 | | | 25 | | | µA |
| I _{IL} | V _{CC} = MAX, V _I = 0.5 V | -0.25 | | | -0.25 | | | mA |
| I _{CC} | V _{CC} = MAX | 105 | 135 | | 105 | 135 | mA | |

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MJ | | | J OR N | | | UNIT |
|---|---------------------------------------|-----|------|-----|--------|------|-----|------|
| | | MIN | TYP‡ | MAX | MIN | TYP‡ | MAX | |
| t _{a(A)} Access time from address | C _L = 30 pF | 35 | 75 | | 35 | 65 | ns | |
| t _{a(S)} Access time from chip select (enable time) | R _{L1} = 300 Ω | 20 | 45 | | 20 | 35 | ns | |
| t _{PLH} Propagation delay time low-to-high-level output from chip select | R _{L2} = 600 Ω See Note 3 | 15 | 45 | | 15 | 35 | ns | |

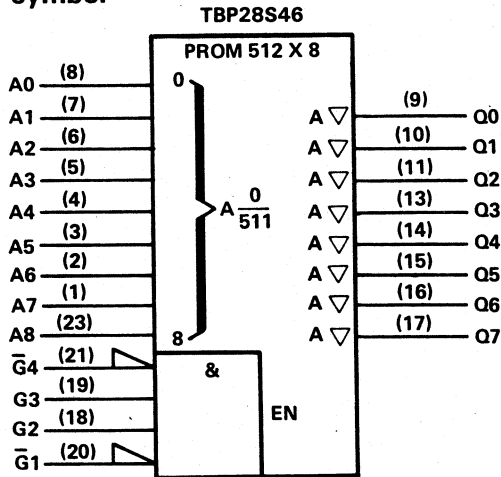
†For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

‡All typical values are at V_{CC} = 5 V, T_A = 25 °C.

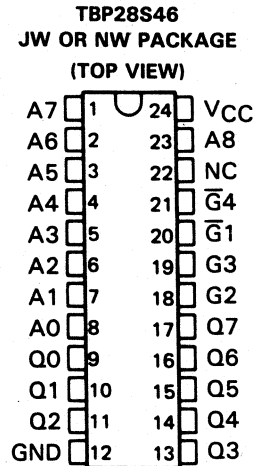
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

TBP28S46
4096 BITS (512 WORDS BY 8 BITS)
STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

logic symbol



pin assignment



recommended operating conditions

| PARAMETER | MJW | | | JW OR NW | | | UNIT |
|---|-----|-----|-----|----------|-----|------|------|
| | MIN | NOM | MAX | MIN | NOM | MAX | |
| VCC Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| V _{IH} High-level input voltage | 2 | | | 2 | | | V |
| V _{IL} Low-level input voltage | | | 0.8 | | | 0.8 | V |
| I _{OH} High-level output current | | | -2 | | | -6.5 | mA |
| I _{OL} Low-level output current | | | 16 | | | 16 | mA |
| T _A Operating free-air temperature range | -55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS [†] | MJW | | | JW OR NW | | | UNIT |
|------------------------------|--|-----|------------------|-------|----------|------------------|-------|------|
| | | MIN | TYP [‡] | MAX | MIN | TYP [‡] | MAX | |
| V _{IK} | V _{CC} = MIN, I _I = -18 mA | | | -1.2 | | | -1.2 | V |
| V _{OH} | V _{CC} = MIN, I _{OH} = MAX | 2.4 | 3.1 | | 2.4 | 3.1 | | V |
| V _{OL} | V _{CC} = MIN, I _{OL} = 16 mA | | | 0.5 | | | 0.5 | V |
| I _{OZH} | V _{CC} = MAX, V _O = 2.4 V | | | 50 | | | 50 | μA |
| I _{OZL} | V _{CC} = MAX, V _O = 0.5 V | | | -50 | | | -50 | μA |
| I _I | V _{CC} = MAX, V _I = 5.5 V | | | 1 | | | 1 | mA |
| I _{IH} | V _{CC} = MAX, V _I = 2.7 V | | | 25 | | | 25 | μA |
| I _{IL} | V _{CC} = MAX, V _I = 0.5 V | | | -0.25 | | | -0.25 | mA |
| I _{OS} [§] | V _{CC} = MAX | -15 | | -100 | -20 | | -100 | mA |
| I _{CC} | V _{CC} = MAX | | 100 | 135 | | 100 | 135 | mA |

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MJW | | | JW OR NW | | | UNIT |
|--|-------------------------------------|-----|------------------|-----|----------|------------------|-----|------|
| | | MIN | TYP [‡] | MAX | MIN | TYP [‡] | MAX | |
| t _{a(A)} Access time from address | C _L = 30 pF | | 35 | 70 | | 35 | 60 | ns |
| t _{a(S)} Access time from chip select (enable time) | See Note 3 | | 20 | 45 | | 20 | 35 | ns |
| t _{dis} Disable time | C _L = 5 pF See Note 3 | | 15 | 40 | | 15 | 35 | ns |

[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

[§]Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

4 PROMS

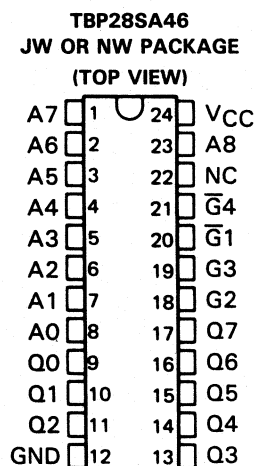
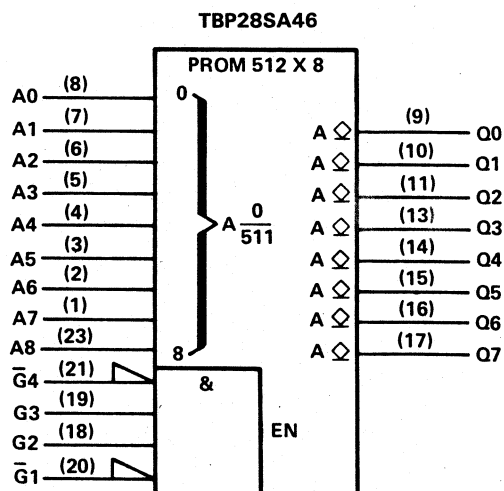
TBP28SA46

4096 BITS (512 WORDS BY 8 BITS)

STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH OPEN-COLLECTOR OUTPUTS

logic symbol

pin assignment



recommended operating conditions

| PARAMETER | MJW | | | JW OR NW | | | UNIT |
|---|-----|-----|-----|----------|-----|------|------|
| | MIN | NOM | MAX | MIN | NOM | MAX | |
| V _{CC} Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| V _{IH} High-level input voltage | 2 | | | 2 | | | V |
| V _{IL} Low-level input voltage | | | 0.8 | | | 0.8 | V |
| V _{OH} High-level output voltage | | | 5.5 | | | 5.5 | V |
| I _{OL} Low-level output current | | | 16 | | | 16 | mA |
| T _A Operating free-air temperature range | -55 | | 125 | 0 | | 70 | °C |

4

PROMS

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS [†] | MJW | | | JW OR NW | | | UNIT |
|-----------------|--|-----|------------------|-------|----------|------------------|-------|------|
| | | MIN | TYP [‡] | MAX | MIN | TYP [‡] | MAX | |
| V _{IK} | V _{CC} = MIN, I _I = -18 mA | | | -1.2 | | | -1.2 | V |
| I _{OH} | V _{CC} = MIN, V _{OH} = 2.4 V | | | 0.05 | | | 0.05 | mA |
| | | | | 0.1 | | | 0.1 | |
| V _{OL} | V _{CC} = MIN, I _{OL} = 16 mA | | | 0.5 | | | 0.5 | V |
| I _I | V _{CC} = MAX, V _I = 5.5 V | | | 1 | | | 1 | mA |
| I _{IH} | V _{CC} = MAX, V _I = 2.7 V | | | 25 | | | 25 | μA |
| I _{IL} | V _{CC} = MAX, V _I = 0.5 V | | | -0.25 | | | -0.25 | mA |
| I _{CC} | V _{CC} = MAX | 100 | 135 | | 100 | 135 | | mA |

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MJW | | | JW OR NW | | | UNIT |
|---|---------------------------------------|-----|------------------|-----|----------|------------------|-----|------|
| | | MIN | TYP [‡] | MAX | MIN | TYP [‡] | MAX | |
| t _{a(A)} Access time from address | C _L = 30 pF | | 35 | 75 | | 35 | 65 | ns |
| t _{a(S)} Access time from chip select (enable time) | R _{L1} = 300 Ω | | 20 | 45 | | 20 | 35 | ns |
| t _{PLH} Propagation delay time low-to-high-level output from chip select | R _{L2} = 600 Ω See Note 3 | | 15 | 40 | | 15 | 35 | ns |

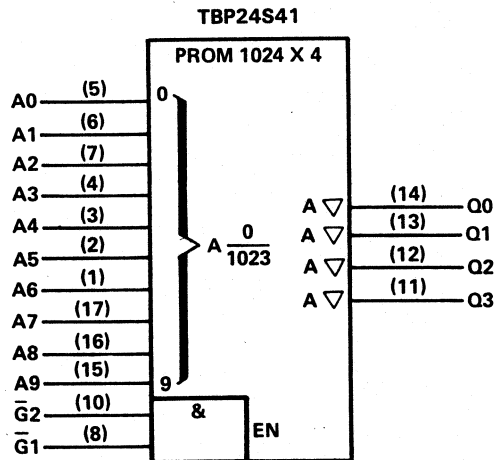
[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

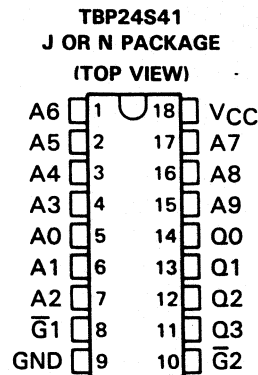
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

TBP24S41
4096 BITS (1024 WORDS BY 4 BITS)
STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

logic symbol



pin assignment



recommended operating conditions

| PARAMETER | MJ | | | J OR N | | | UNIT |
|---|-----|-----|-----|--------|-----|------|------|
| | MIN | NOM | MAX | MIN | NOM | MAX | |
| V _{CC} Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| V _{IH} High-level input voltage | 2 | | | 2 | | | V |
| V _{IL} Low-level input voltage | | | 0.8 | | | 0.8 | V |
| I _{OH} High-level output current | | | -2 | | | -3.2 | mA |
| I _{OL} Low-level output current | | | 16 | | | 16 | mA |
| T _A Operating free-air temperature range | -55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS [†] | MJ | | | J OR N | | | UNIT |
|------------------------------|--|-----|------------------|-------|--------|------------------|-------|------|
| | | MIN | TYP [‡] | MAX | MIN | TYP [‡] | MAX | |
| V _{IK} | V _{CC} = MIN, I _I = -18 mA | | | -1.2 | | | -1.2 | V |
| V _{OH} | V _{CC} = MIN, I _{OH} = MAX | 2.4 | 3.1 | | 2.4 | 3.1 | | V |
| V _{OL} | V _{CC} = MIN, I _{OL} = 16 mA | | | 0.5 | | | 0.5 | V |
| I _{OZH} | V _{CC} = MAX, V _O = 2.4 V | | | 50 | | | 50 | μA |
| I _{OZL} | V _{CC} = MAX, V _O = 0.5 V | | | -50 | | | -50 | μA |
| I _I | V _{CC} = MAX, V _I = 5.5 V | | | 1 | | | 1 | mA |
| I _{IH} | V _{CC} = MAX, V _I = 2.7 V | | | 25 | | | 25 | μA |
| I _{IL} | V _{CC} = MAX, V _I = 0.5 V | | | -0.25 | | | -0.25 | mA |
| I _{OS} [§] | V _{CC} = MAX | -15 | | -100 | -20 | | -100 | mA |
| I _{CC} | V _{CC} = MAX | | 95 | 140 | | 95 | 140 | mA |

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MJ | | | J OR N | | | UNIT |
|--|-------------------------------------|-----|------------------|-----|--------|------------------|-----|------|
| | | MIN | TYP [‡] | MAX | MIN | TYP [‡] | MAX | |
| t _{a(A)} Access time from address | C _L = 30 pF | | 40 | 75 | | 40 | 60 | ns |
| t _{a(S)} Access time from chip select (enable time) | See Note 3 | | 20 | 40 | | 20 | 30 | ns |
| t _{dis} Disable time | C _L = 5 pF See Note 3 | | 20 | 40 | | 20 | 30 | ns |

[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

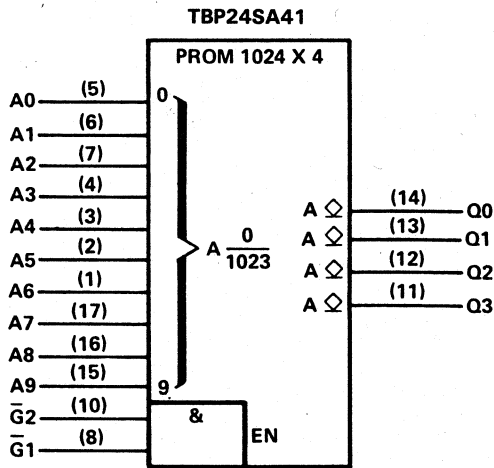
[§]Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

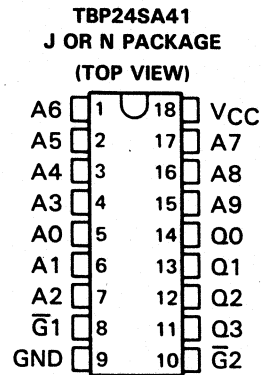
4 PROMS

TBP24SA41
4096 BITS (1024 WORDS BY 4 BITS)
STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH OPEN-COLLECTOR OUTPUTS

logic symbol



pin assignment



recommended operating conditions

| PARAMETER | | MJ | | | J OR N | | | UNIT |
|-----------------|--------------------------------------|-----|-----|-----|--------|-----|------|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | |
| V _{CC} | Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| V _{IH} | High-level input voltage | 2 | | | 2 | | | V |
| V _{IL} | Low-level input voltage | | | 0.8 | | | 0.8 | V |
| V _{OH} | High-level output voltage | | | 5.5 | | | 5.5 | V |
| I _{OL} | Low-level output current | | | 16 | | | 16 | mA |
| T _A | Operating free-air temperature range | -55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS† | MJ | | | J OR N | | | UNIT | |
|-----------------|--|-----|------|-------|--------|------|-------|------|----|
| | | MIN | TYP‡ | MAX | MIN | TYP‡ | MAX | | |
| V _{IK} | V _{CC} = MIN, I _I = -18 mA | | | -1.2 | | | -1.2 | V | |
| I _{OH} | V _{CC} = MIN, V _{OH} = 2.4 V | | | 0.05 | | | 0.05 | mA | |
| | | | | 0.1 | | | 0.1 | | |
| V _{OL} | V _{CC} = MIN, I _{OL} = 16 mA | | | 0.5 | | | 0.5 | V | |
| I _I | V _{CC} = MAX, V _I = 5.5 V | | | 1 | | | 1 | mA | |
| I _{IH} | V _{CC} = MAX, V _I = 2.7 V | | | 25 | | | 25 | µA | |
| I _{IL} | V _{CC} = MAX, V _I = 0.5 V | | | -0.25 | | | -0.25 | mA | |
| I _{CC} | V _{CC} = MAX | | | 95 | 140 | | 95 | 140 | mA |

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MJ | | | J OR N | | | UNIT | |
|-------------------|--|-----|------|-----|--------|------|-----|------|----|
| | | MIN | TYP‡ | MAX | MIN | TYP‡ | MAX | | |
| t _{a(A)} | Access time from address | | | 40 | 75 | | 40 | 60 | ns |
| t _{a(S)} | Access time from chip select (enable time) | | | 20 | 40 | | 20 | 30 | ns |
| t _{PLH} | Propagation delay time low-to-high-level output from chip select | | | 20 | 40 | | 20 | 30 | ns |

†For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

‡All typical values are at V_{CC} = 5 V, T_A = 25 °C.

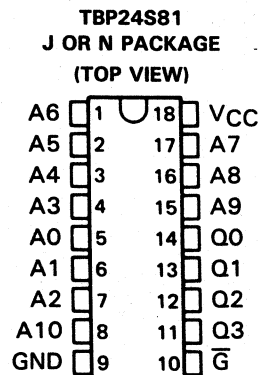
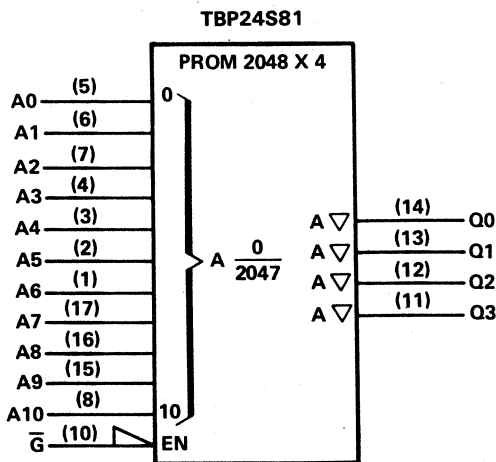
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

4 PROMS

TBP24S81
8192 BITS (2048 WORDS BY 4 BITS)
STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

logic symbol

pin assignment



recommended operating conditions

| PARAMETER | MJ | | | J OR N | | | UNIT |
|---|-----|-----|-----|--------|-----|------|------|
| | MIN | NOM | MAX | MIN | NOM | MAX | |
| V _{CC} Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| V _{IH} High-level input voltage | 2 | | | 2 | | | V |
| V _{IL} Low-level input voltage | | | 0.8 | | | 0.8 | V |
| I _{OH} High-level output current | | | -2 | | | -3.2 | mA |
| I _{OL} Low-level output current | | | 16 | | | 16 | mA |
| T _A Operating free-air temperature range | -55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS [†] | MJ | | | J OR N | | | UNIT |
|------------------------------|--|-----|------------------|-------|--------|------------------|-------|------|
| | | MIN | TYP [‡] | MAX | MIN | TYP [‡] | MAX | |
| V _{IK} | V _{CC} = MIN, I _I = -18 mA | | | -1.2 | | | -1.2 | V |
| V _{OH} | V _{CC} = MIN, I _{OH} = MAX | 2.4 | 3.1 | | 2.4 | 3.1 | | V |
| V _{OL} | V _{CC} = MIN, I _{OL} = 16 mA | | | 0.5 | | | 0.5 | V |
| I _{OZH} | V _{CC} = MAX, V _O = 2.4 V | | | 50 | | | 50 | μA |
| I _{OZL} | V _{CC} = MAX, V _O = 0.5 V | | | -50 | | | -50 | μA |
| I _I | V _{CC} = MAX, V _I = 5.5 V | | | 1 | | | 1 | mA |
| I _{IH} | V _{CC} = MAX, V _I = 2.7 V | | | 25 | | | 25 | μA |
| I _{IL} | V _{CC} = MAX, V _I = 0.5 V | | | -0.25 | | | -0.25 | mA |
| I _{OS} [§] | V _{CC} = MAX | -15 | | -100 | -20 | | -100 | mA |
| I _{CC} | V _{CC} = MAX | | 125 | 175 | | 125 | 175 | mA |

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MJ | | | J OR N | | | UNIT |
|--|-------------------------------------|-----|------------------|-----|--------|------------------|-----|------|
| | | MIN | TYP [‡] | MAX | MIN | TYP [‡] | MAX | |
| t _{a(A)} Access time from address | C _L = 30 pF | | 45 | 85 | | 45 | 70 | ns |
| t _{a(S)} Access time from chip select (enable time) | See Note 3 | | 20 | 50 | | 20 | 40 | ns |
| t _{dis} Disable time | C _L = 5 pF See Note 3 | | 20 | 50 | | 20 | 40 | ns |

[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

[§]Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

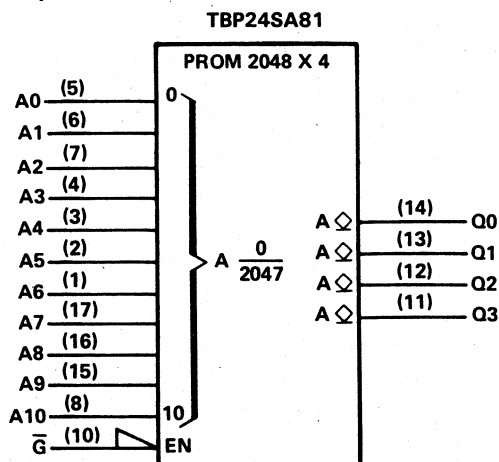
4 PROMS

TBP24SA81

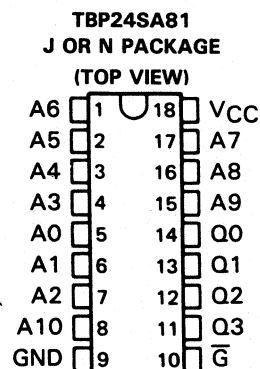
8192 BITS (2048 WORDS BY 4 BITS)

STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH OPEN-COLLECTOR OUTPUTS

logic symbol



pin assignment



recommended operating conditions

| PARAMETER | MJ | | | J OR N | | | UNIT |
|---|-----|-----|-----|--------|-----|------|------|
| | MIN | NOM | MAX | MIN | NOM | MAX | |
| V _{CC} Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| V _{IH} High-level input voltage | 2 | | | 2 | | | V |
| V _{IL} Low-level input voltage | | | 0.8 | | | 0.8 | V |
| V _{OH} High-level output voltage | | | 5.5 | | | 5.5 | V |
| I _{OL} Low-level output current | | | 16 | | | 16 | mA |
| T _A Operating free-air temperature range | -55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS† | MJ | | | J OR N | | | UNIT | |
|-----------------|--|-----|------|-------|--------|------|-------|------|----|
| | | MIN | TYP‡ | MAX | MIN | TYP‡ | MAX | | |
| V _{IK} | V _{CC} = MIN, I _I = -18 mA | | | -1.2 | | | -1.2 | V | |
| I _{OH} | V _{CC} = MIN, V _{OH} = 2.4 V | | | 0.05 | | | 0.05 | VmA | |
| | | | | 0.1 | | | 0.1 | | |
| V _{OL} | V _{CC} = MIN, I _{OL} = 16 mA | | | 0.5 | | | 0.5 | V | |
| I _I | V _{CC} = MAX, V _I = 5.5 V | | | 1 | | | 1 | mA | |
| I _{IH} | V _{CC} = MAX, V _I = 2.7 V | | | 25 | | | 25 | μA | |
| I _{IL} | V _{CC} = MAX, V _I = 0.5 V | | | -0.25 | | | -0.25 | mA | |
| I _{CC} | V _{CC} = MAX | | | 125 | 175 | | 125 | 175 | mA |

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MJ | | | J OR N | | | UNIT |
|---|---------------------------------------|-----|------|-----|--------|------|-----|------|
| | | MIN | TYP‡ | MAX | MIN | TYP‡ | MAX | |
| t _{a(A)} Access time from address | C _L = 30 pF | | 45 | 95 | | 45 | 70 | ns |
| t _{a(S)} Access time from chip select (enable time) | R _{L1} = 300 Ω | | 20 | 50 | | 20 | 40 | ns |
| t _{PLH} Propagation delay time low-to-high-level output from chip select | R _{L2} = 600 Ω See Note 3 | | 20 | 50 | | 20 | 40 | ns |

†For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

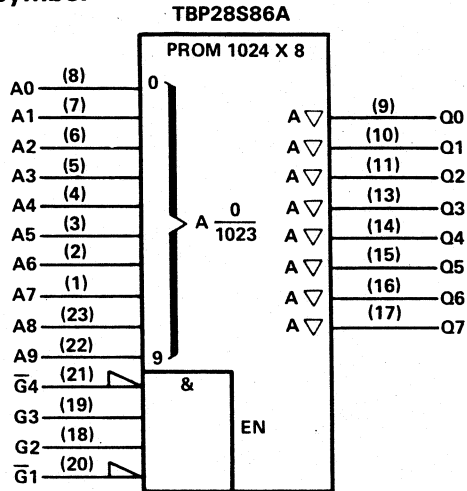
‡All typical values are at V_{CC} = 5 V, T_A = 25°C.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

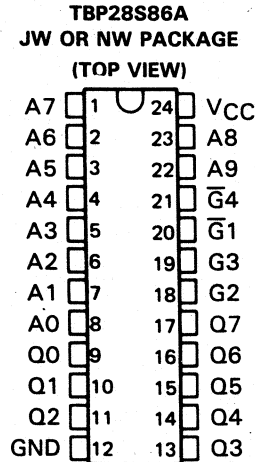
4 PROMS

TBP28S86A
8192 BITS (1024 WORDS BY 8 BITS)
STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

logic symbol



pin assignment



recommended operating conditions

| PARAMETER | MJW | | | JW OR NW | | | UNIT |
|---|-----|-----|-----|----------|-----|------|------|
| | MIN | NOM | MAX | MIN | NOM | MAX | |
| V _{CC} Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| V _{IH} High-level input voltage | 2 | | | 2 | | | V |
| V _{IL} Low-level input voltage | | | 0.8 | | | 0.8 | V |
| I _{OH} High-level output current | | | -2 | | | -3.2 | mA |
| I _{OL} Low-level output current | | | 12 | | | 12 | mA |
| T _A Operating free-air temperature range | -55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS [†] | MJW | | | JW OR NW | | | UNIT |
|------------------------------|--|-----|------------------|-------|----------|------------------|-------|------|
| | | MIN | TYP [‡] | MAX | MIN | TYP [‡] | MAX | |
| V _{IK} | V _{CC} = MIN, I _I = -18 mA | | | -1.2 | | | -1.2 | V |
| V _{OH} | V _{CC} = MIN, I _{OH} = MAX | 2.4 | 3.1 | | 2.4 | 3.1 | | V |
| V _{OL} | V _{CC} = MIN, I _{OL} = 12 mA | | | 0.5 | | | 0.5 | V |
| I _{OZH} | V _{CC} = MAX, V _O = 2.4 V | | | 50 | | | 50 | μA |
| I _{OZL} | V _{CC} = MAX, V _O = 0.5 V | | | -50 | | | -50 | μA |
| I _I | V _{CC} = MAX, V _I = 5.5 V | | | 1 | | | 1 | mA |
| I _{IH} | V _{CC} = MAX, V _I = 2.7 V | | | 25 | | | 25 | μA |
| I _{IL} | V _{CC} = MAX, V _I = 0.5 V | | | -0.25 | | | -0.25 | mA |
| I _{OS} [§] | V _{CC} = MAX | -15 | | -100 | -20 | | -100 | mA |
| I _{CC} | V _{CC} = MAX | | 110 | 170 | | 110 | 165 | mA |

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MJW | | | JW OR NW | | | UNIT |
|--|-------------------------------------|-----|------------------|-----|----------|------------------|-----|------|
| | | MIN | TYP [‡] | MAX | MIN | TYP [‡] | MAX | |
| t _{aA}) Access time from address | C _L = 30 pF | | 35 | 80 | | 35 | 65 | ns |
| t _{a(S)} Access time from chip select (enable time) | See Note 3 | | 20 | 50 | | 20 | 40 | ns |
| t _{dis} Disable time | C _L = 5 pF See Note 3 | | 15 | 40 | | 15 | 35 | ns |

[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

[§]Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

4

PROMS

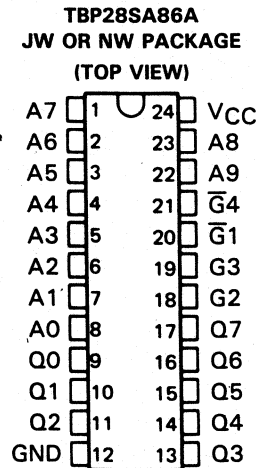
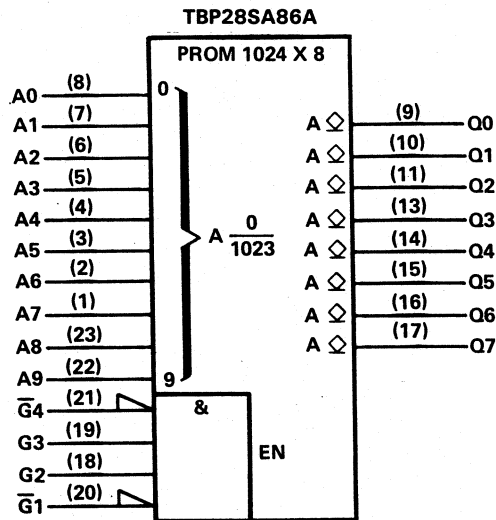
TBP28SA86A

8192 BITS (1024 WORDS BY 8 BITS)

STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH OPEN-COLLECTOR OUTPUTS

logic symbol

pin assignment



recommended operating conditions

| PARAMETER | MJW | | | JW OR NW | | | UNIT |
|---|-----|-----|-----|----------|-----|------|------|
| | MIN | NOM | MAX | MIN | NOM | MAX | |
| V _{CC} Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| V _{IH} High-level input voltage | 2 | | | 2 | | | V |
| V _{IL} Low-level input voltage | | | 0.8 | | | 0.8 | V |
| V _{OH} High-level output voltage | | | 5.5 | | | 5.5 | V |
| I _{OL} Low-level output current | | | 12 | | | 12 | mA |
| T _A Operating free-air temperature range | -55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS [†] | MJW | | | JW OR NW | | | UNIT |
|-----------------|--|-----|------------------|-------|----------|------------------|-------|------|
| | | MIN | TYP [‡] | MAX | MIN | TYP [‡] | MAX | |
| V _{IK} | V _{CC} = MIN, I _I = -18 mA | | | -1.2 | | | -1.2 | V |
| I _{OH} | V _{CC} = MIN, V _{OH} = 2.4 V | | | 0.05 | | | 0.05 | mA |
| | | | | 0.1 | | | 0.1 | |
| V _{OL} | V _{CC} = MIN, I _{OL} = 12 mA | | | 0.5 | | | 0.5 | V |
| I _I | V _{CC} = MAX, V _I = 5.5 V | | | 1 | | | 1 | mA |
| I _{IH} | V _{CC} = MAX, V _I = 2.7 V | | | 25 | | | 25 | μA |
| I _{IL} | V _{CC} = MAX, V _I = 0.5 V | | | -0.25 | | | -0.25 | mA |
| I _{CC} | V _{CC} = MAX | 125 | 175 | | 125 | 175 | | mA |

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MJW | | | JW OR NW | | | UNIT |
|---|--|-----|------------------|-----|----------|------------------|-----|------|
| | | MIN | TYP [‡] | MAX | MIN | TYP [‡] | MAX | |
| t _{a(A)} Access time from address | C _L = 30 pF R _{L1} = 300 Ω R _{L2} = 600 Ω See Note 3 | 35 | 80 | | 35 | 70 | ns | |
| t _{a(S)} Access time from chip select (enable time) | | 20 | 50 | | 20 | 40 | ns | |
| t _{PLH} Propagation delay time low-to-high-level output from chip select | | 15 | 40 | | 15 | 35 | ns | |

[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

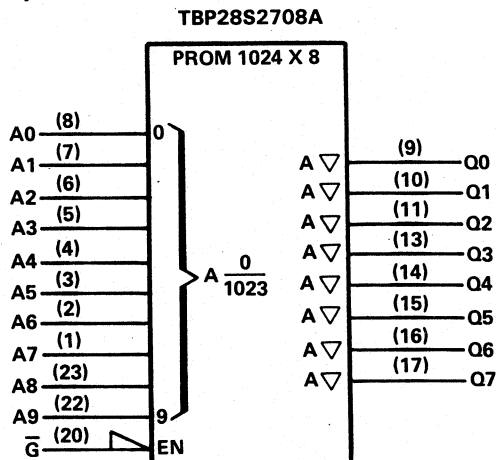
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

4

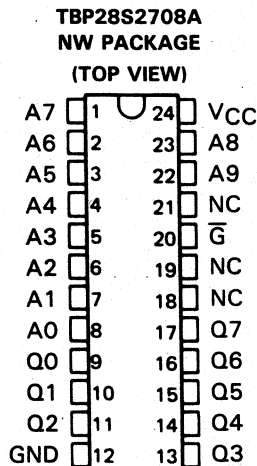
PROMS

TBP28S2708A
8192 BITS (1024 WORDS BY 8 BITS)
STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

logic symbol



pin assignment



recommended operating conditions

| PARAMETER | NW | | | UNIT |
|---|------|-----|------|---------|
| | MIN | NOM | MAX | |
| V _{CC} Supply voltage | 4.75 | 5 | 5.25 | V |
| V _{IH} High-level input voltage | 2 | | | V |
| V _{IL} Low-level input voltage | | | | 0.8 V |
| I _{OH} High-level output current | | | | -3.2 mA |
| I _{OL} Low-level output current | | | | 12 mA |
| T _A Operating free-air temperature range | 0 | | | 70 °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | NW | | | UNIT |
|-------------------|---|-------|------|-----|------|
| | | MIN | TYP† | MAX | |
| V _{IK} | V _{CC} = 4.75, I _I = -18 mA | -1.2 | | | V |
| V _{OH} | V _{CC} = 4.75, I _{OH} = -3.2 mA | 2.4 | 3.1 | | V |
| V _{OL} | V _{CC} = 4.75, I _{OL} = 12 mA | 0.5 | | | V |
| I _{OZH} | V _{CC} = 5.25, V _O = 2.4 V | 50 | | | μA |
| I _{OZL} | V _{CC} = 5.25, V _O = 0.5 V | -50 | | | μA |
| I _I | V _{CC} = 5.25, V _I = 5.5 V | 1 | | | mA |
| I _{IH} | V _{CC} = 5.25, V _I = 2.7 V | 25 | | | μA |
| I _{IL} | V _{CC} = 5.25, V _I = 0.5 V | -0.25 | | | mA |
| I _{OS} ‡ | V _{CC} = 5.25 | -20 | -100 | | mA |
| I _{CC} | V _{CC} = 5.25 | 110 | | 165 | mA |

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

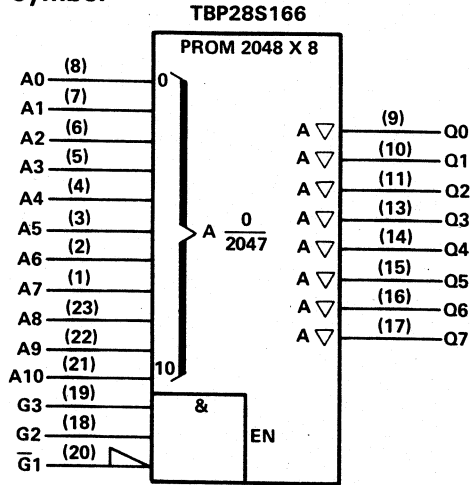
| PARAMETER | TEST CONDITIONS | NW | | | UNIT |
|--|-------------------------------------|-----|------|-----|------|
| | | MIN | TYP† | MAX | |
| t _{a(A)} Access time from address | C _L = 30 pF | 45 | | 70 | ns |
| t _{a(S)} Access time from chip select (enable time) | See Note 3 | 20 | | 40 | ns |
| t _{dis} Disable time | C _L = 5 pF See Note 3 | 20 | | 40 | ns |

†All typical values are at V_{CC} = 5 V, T_A = 25 °C.
 ‡Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.
 NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

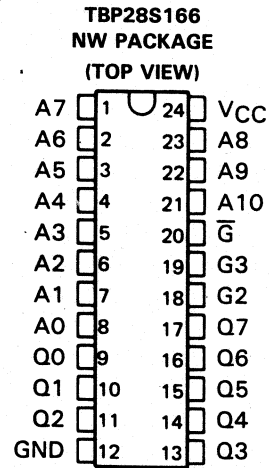
4 PROMS

TBP28S166
16,384 BITS (2084 WORDS BY 8 BITS)
STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

logic symbol



pin assignment



recommended operating conditions

| PARAMETER | NW | | | UNIT |
|---|------|-----|------|------|
| | MIN | NOM | MAX | |
| V _{CC} Supply voltage | 4.75 | 5 | 5.25 | V |
| V _{IH} High-level input voltage | 2 | | | V |
| V _{IL} Low-level input voltage | | | 0.8 | V |
| I _{OH} High-level output current | | | -3.2 | mA |
| I _{OL} Low-level output current | | | 16 | mA |
| T _A Operating free-air temperature range | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | NW | | | UNIT |
|-------------------|---|-----|------|-------|------|
| | | MIN | TYP† | MAX | |
| V _{IK} | V _{CC} = 4.75, I _I = -18 mA | | | -1.2 | V |
| V _{OH} | V _{CC} = 4.75, I _{OH} = -3.2 mA | 2.4 | 3.1 | | V |
| V _{OL} | V _{CC} = 4.75, I _{OL} = 16 mA | | | 0.5 | V |
| I _{OZH} | V _{CC} = 5.25, V _O = 2.4 V | | | 50 | μA |
| I _{OZL} | V _{CC} = 5.25, V _O = 0.5 V | | | -50 | μA |
| I _I | V _{CC} = 5.25, V _I = 5.5 V | | | 1 | mA |
| I _{IH} | V _{CC} = 5.25, V _I = 2.7 V | | | 25 | μA |
| I _{IL} | V _{CC} = 5.25, V _I = 0.5 V | | | -0.25 | mA |
| I _{OS} ‡ | V _{CC} = 5.25 | -20 | | -100 | mA |
| I _{CC} | V _{CC} = 5.25 | | 130 | 175 | mA |

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | NW | | | UNIT |
|--|-------------------------------------|-----|------|-----|------|
| | | MIN | TYP† | MAX | |
| t _{a(A)} Access time from address | C _L = 30 pF | | 35 | 75 | ns |
| t _{a(S)} Access time from chip select (enable time) | See Note 3 | | 15 | 40 | ns |
| t _{dis} Disable time | C _L = 5 pF See Note 3 | | 15 | 40 | ns |

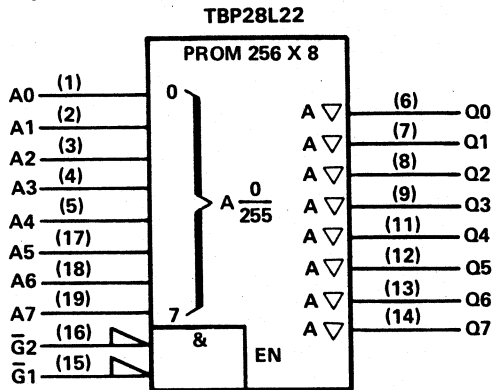
† All typical values are at V_{CC} = 5 V, T_A = 25°C.

‡ Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

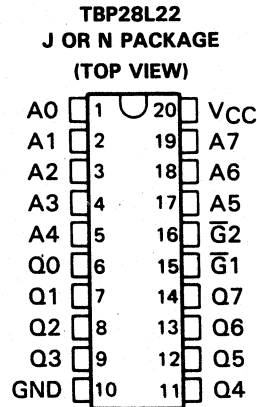
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

TBP28L22
2048 BITS (256 WORDS BY 8 BITS)
LOW-POWER PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

logic symbol



pin assignment



recommended operating conditions

| PARAMETER | MJ | | | J OR N | | | UNIT |
|---|-----|-----|-----|--------|-----|------|------|
| | MIN | NOM | MAX | MIN | NOM | MAX | |
| V _{CC} Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| V _{IH} High-level input voltage | 2 | | | 2 | | | V |
| V _{IL} Low-level input voltage | | | 0.8 | | | 0.8 | V |
| I _{OH} High-level output current | | | -2 | | | -6.5 | mA |
| I _{OL} Low-level output current | | | 16 | | | 16 | mA |
| T _A Operating free-air temperature range | -55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS† | MJ | | | J OR N | | | UNIT |
|-------------------|--|-----|------|-------|--------|------|-------|------|
| | | MIN | TYP‡ | MAX | MIN | TYP‡ | MAX | |
| V _{IK} | V _{CC} = MIN, I _I = -18 mA | | | -1.2 | | | -1.2 | V |
| V _{OH} | V _{CC} = MIN, I _{OH} = MAX | 2.4 | 3.1 | | 2.4 | 3.1 | | V |
| V _{OL} | V _{CC} = MIN, I _{OL} = 16 mA | | | 0.5 | | | 0.5 | V |
| I _{OZH} | V _{CC} = MAX, V _O = 2.4 V | | | 50 | | | 50 | μA |
| I _{OZL} | V _{CC} = MAX, V _O = 0.5 V | | | -50 | | | -50 | μA |
| I _I | V _{CC} = MAX, V _I = 5.5 V | | | 1 | | | 1 | mA |
| I _{IH} | V _{CC} = MAX, V _I = 2.7 V | | | 25 | | | 25 | μA |
| I _{IL} | V _{CC} = MAX, V _I = 0.5 V | | | -0.25 | | | -0.25 | mA |
| I _{OS} § | V _{CC} = MAX | -25 | | -100 | -30 | | -100 | mA |
| I _{CC} | * V _{CC} = MAX | | 75 | 100 | | 75 | 100 | mA |

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MJ | | | J OR N | | | UNIT |
|--|-------------------------------------|-----|------|-----|--------|------|-----|------|
| | | MIN | TYP‡ | MAX | MIN | TYP‡ | MAX | |
| t _{a(A)} Access time from address | C _L = 30 pF | | 45 | 75 | | 45 | 70 | ns |
| t _{a(S)} Access time from chip select (enable time) | See Note 3 | | 20 | 40 | | 20 | 35 | ns |
| t _{dis} Disable time | C _L = 5 pF See Note 3 | | 15 | 35 | | 15 | 30 | ns |

†For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

‡All typical values are at V_{CC} = 5 V, T_A = 25°C.

§Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

4

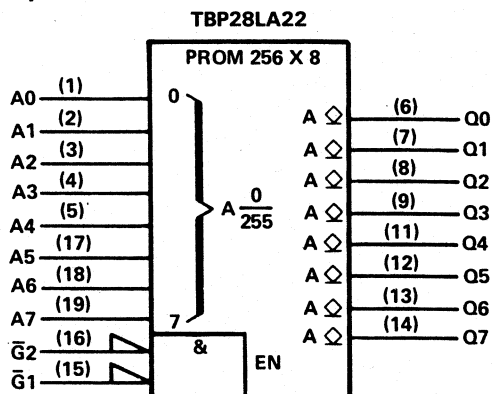
PROMS

TBP28LA22

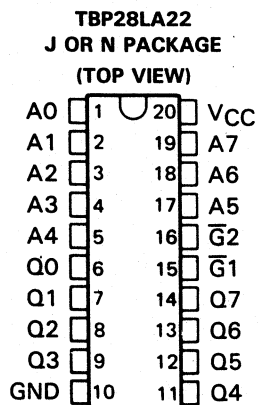
2048 BITS (256 WORDS BY 8 BITS)

LOW-POWER PROGRAMMABLE READ-ONLY MEMORIES WITH OPEN-COLLECTOR OUTPUTS

logic symbol



pin assignment



recommended operating conditions

| PARAMETER | MJ | | | J OR N | | | UNIT |
|---|-----|-----|-----|--------|-----|------|------|
| | MIN | NOM | MAX | MIN | NOM | MAX | |
| V _{CC} Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| V _{IH} High-level input voltage | 2 | | | 2 | | | V |
| V _{IL} Low-level input voltage | | | 0.8 | | | 0.8 | V |
| V _{OH} High-level output voltage | | | 5.5 | | | 5.5 | V |
| I _{OL} Low-level output current | | | 16 | | | 16 | mA |
| T _A Operating free-air temperature range | -55 | | 125 | 0 | | 70 | °C |

4

PROMS

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS† | MJ | | | J OR N | | | UNIT |
|-----------------|--|-----|------|-------|--------|------|-------|--------|
| | | MIN | TYP‡ | MAX | MIN | TYP‡ | MAX | |
| V _{IK} | V _{CC} = MIN, I _I = -18 mA | | | -1.2 | | | -1.2 | V |
| I _{OH} | V _{CC} = MIN, V _{OH} = 2.4 V | | | 0.05 | | | 0.05 | mA |
| | | | | 0.1 | | | 0.1 | |
| V _{OL} | V _{CC} = MIN, I _{OL} = 16 mA | | | 0.5 | | | 0.5 | V |
| I _I | V _{CC} = MAX, V _I = 5.5 V | | | 1 | | | 1 | mA |
| I _{IH} | V _{CC} = MAX, V _I = 2.7 V | | | 25 | | | 25 | μA |
| I _{IL} | V _{CC} = MAX, V _I = 0.5 V | | | -0.25 | | | -0.25 | mA |
| I _{CC} | V _{CC} = MAX | | | 75 | | | 75 | 100 mA |

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MJ | | | J OR N | | | UNIT | |
|---|--|-----|------|-----|--------|------|-----|------|----|
| | | MIN | TYP‡ | MAX | MIN | TYP‡ | MAX | | |
| t _{aA}) Access time from address | C _L = 30 pF R _{L1} = 300 Ω R _{L2} = 600 Ω See Note 3 | | | 40 | 80 | | 45 | 75 | ns |
| t _{a(S)}) Access time from chip select (enable time) | | | | 20 | 40 | | 20 | 35 | ns |
| t _{PLH}) Propagation delay time low-to-high-level output from chip select | | | | | 15 | 35 | | 15 | 30 |

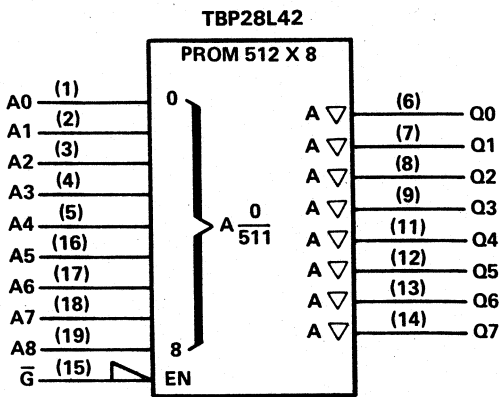
†For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

‡All typical values are at V_{CC} = 5 V, T_A = 25°C.

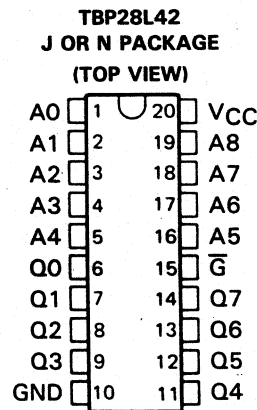
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

TBP28L42
4096 BITS (512 WORDS BY 8 BITS)
LOW-POWER PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

logic symbol



pin assignment



recommended operating conditions

| PARAMETER | MJ | | | J OR N | | | UNIT |
|---|-----|-----|-----|--------|-----|------|------|
| | MIN | NOM | MAX | MIN | NOM | MAX | |
| V _{CC} Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| V _{IH} High-level input voltage | 2 | | | 2 | | | V |
| V _{IL} Low-level input voltage | | | 0.8 | | | 0.8 | V |
| I _{OH} High-level output current | | | -1 | | | -1.6 | mA |
| I _{OL} Low-level output current | | | 8 | | | 8 | mA |
| T _A Operating free-air temperature range | -55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS [†] | MJ | | | J OR N | | | UNIT |
|------------------------------|--|-----|------------------|-------|--------|------------------|-------|------|
| | | MIN | TYP [‡] | MAX | MIN | TYP [‡] | MAX | |
| V _{IK} | V _{CC} = MIN, I _I = -18 mA | | | -1.2 | | | -1.2 | V |
| V _{OH} | V _{CC} = MIN, I _{OH} = MAX | 2.4 | 3.1 | | 2.4 | 3.1 | | V |
| V _{OL} | V _{CC} = MIN, I _{OL} = 8 mA | | | 0.5 | | | 0.5 | V |
| I _{OZH} | V _{CC} = MAX, V _O = 2.4 V | | | 50 | | | 50 | μA |
| I _{OZL} | V _{CC} = MAX, V _O = 0.5 V | | | -50 | | | -50 | μA |
| I _I | V _{CC} = MAX, V _I = 5.5 V | | | 1 | | | 1 | mA |
| I _{IH} | V _{CC} = MAX, V _I = 2.7 V | | | 25 | | | 25 | μA |
| I _{IL} | V _{CC} = MAX, V _I = 0.5 V | | | -0.25 | | | -0.25 | mA |
| I _{OS} [§] | V _{CC} = MAX | -10 | | -100 | -10 | | -100 | mA |
| I _{CC} | V _{CC} = MAX | | 50 | 85 | | 50 | 85 | mA |

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MJ | | | J OR N | | | UNIT |
|--|-------------------------------------|-----|------------------|-----|--------|------------------|-----|------|
| | | MIN | TYP [‡] | MAX | MIN | TYP [‡] | MAX | |
| t _{a(A)} Access time from address | C _L = 30 pF | | 55 | 110 | | 55 | 95 | ns |
| t _{a(S)} Access time from chip select (enable time) | See Note 3 | | 25 | 60 | | 25 | 60 | ns |
| t _{dis} Disable time | C _L = 5 pF See Note 3 | | 25 | 50 | | 25 | 40 | ns |

[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

[§]Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

4

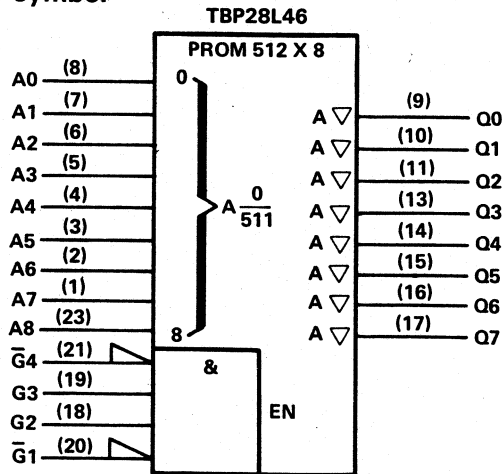
PROMS

TBP28L46

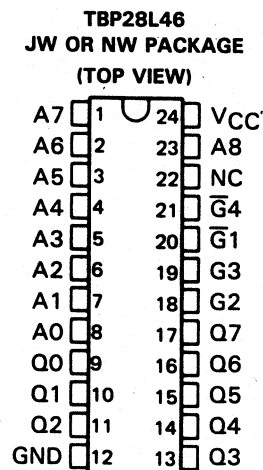
4096 BITS (512 WORDS BY 8 BITS)

LOW-POWER PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

logic symbol:



pin assignment



recommended operating conditions

| PARAMETER | MJW | | | JW OR NW | | | UNIT |
|---|-----|-----|-----|----------|-----|------|------|
| | MIN | NOM | MAX | MIN | NOM | MAX | |
| V _{CC} Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| V _{IH} High-level input voltage | 2 | | | 2 | | | V |
| V _{IL} Low-level input voltage | | | | | | | V |
| I _{OH} High-level output current | | | 0.8 | | | 0.8 | V |
| I _{OL} Low-level output current | | | -1 | | | -1.6 | mA |
| T _A Operating free-air temperature range | | | 8 | | | 8 | mA |
| | -55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS† | MJW | | | JW OR NW | | | UNIT |
|-------------------|--|-----|------|-------|----------|------|-------|------|
| | | MIN | TYP‡ | MAX | MIN | TYP‡ | MAX | |
| V _{IK} | V _{CC} = MIN, I _I = -18 mA | | | -1.2 | | | -1.2 | V |
| V _{OH} | V _{CC} = MIN, I _{OH} = MAX | 2.4 | 3.1 | | 2.4 | 3.1 | | V |
| V _{OL} | V _{CC} = MIN, I _{OL} = 8 mA | | | 0.5 | | | 0.5 | V |
| I _{OZH} | V _{CC} = MAX, V _O = 2.4 V | | | 50 | | | 50 | μA |
| I _{OZL} | V _{CC} = MAX, V _O = 0.5 V | | | -50 | | | -50 | μA |
| I _I | V _{CC} = MAX, V _I = 5.5 V | | | 1 | | | 1 | mA |
| I _{IH} | V _{CC} = MAX, V _I = 2.7 V | | | 25 | | | 25 | μA |
| I _{IL} | V _{CC} = MAX, V _I = 0.5 V | | | -0.25 | | | -0.25 | mA |
| I _{OS} § | V _{CC} = MAX | -10 | | -100 | -10 | | -100 | mA |
| I _{CC} | V _{CC} = MAX | | 50 | 85 | | 50 | 85 | mA |

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MJW | | | JW OR NW | | | UNIT |
|--|-------------------------------------|-----|------|-----|----------|------|-----|------|
| | | MIN | TYP‡ | MAX | MIN | TYP‡ | MAX | |
| t _{a(A)} Access time from address | C _L = 30 pF | | 55 | 110 | | 55 | 95 | ns |
| t _{a(S)} Access time from chip select (enable time) | See Note 3 | | 25 | 60 | | 25 | 60 | ns |
| t _{dis} Disable time | C _L = 5 pF See Note 3 | | 25 | 50 | | 25 | 40 | ns |

†For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

‡All typical values are at V_{CC} = 5 V, T_A = 25°C.

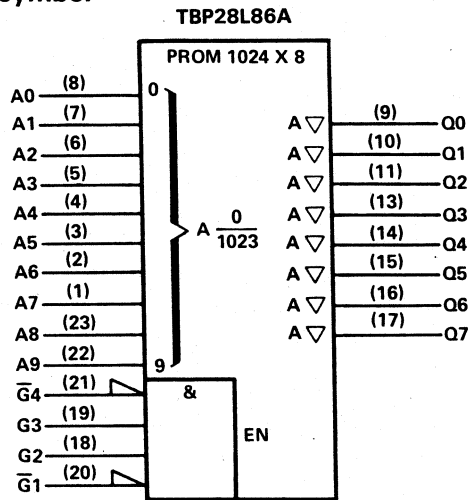
§Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

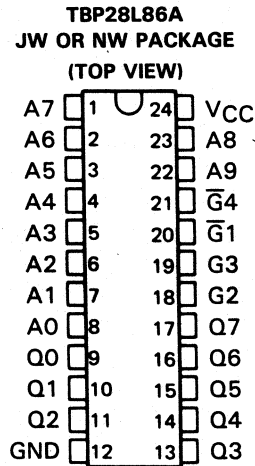
4 PROMS

TBP28L86A
8192 BITS (1024 WORDS BY 8 BITS)
LOW-POWER PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

logic symbol



pin assignment



recommended operating conditions

| PARAMETER | MJW | | | JW OR NW | | | UNIT |
|---|-----|-----|-----|----------|-----|------|------|
| | MIN | NOM | MAX | MIN | NOM | MAX | |
| V _{CC} Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| V _{IH} High-level input voltage | 2 | | | 2 | | | V |
| V _{IL} Low-level input voltage | | | 0.8 | | | 0.8 | V |
| I _{OH} High-level output current | | | -1 | | | -1.6 | mA |
| I _{OL} Low-level output current | | | 8 | | | 8 | mA |
| T _A Operating free-air temperature range | -55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS [†] | MJW | | | JW OR NW | | | UNIT |
|------------------------------|--|-----|------------------|-------|----------|------------------|-------|------|
| | | MIN | TYP [‡] | MAX | MIN | TYP [‡] | MAX | |
| V _{IK} | V _{CC} = MIN, I _I = -18 mA | | | -1.2 | | | -1.2 | V |
| V _{OH} | V _{CC} = MIN, I _{OH} = MAX | 2.4 | 3.1 | | 2.4 | 3.1 | | V |
| V _{OL} | V _{CC} = MIN, I _{OL} = 8 mA | | | 0.5 | | | 0.5 | V |
| I _{OZH} | V _{CC} = MAX, V _O = 2.4 V | | | 50 | | | 50 | μA |
| I _{OZL} | V _{CC} = MAX, V _O = 0.5 V | | | -50 | | | -50 | μA |
| I _I | V _{CC} = MAX, V _I = 5.5 V | | | 1 | | | 1 | mA |
| I _{IH} | V _{CC} = MAX, V _I = 2.7 V | | | 25 | | | 25 | μA |
| I _{IL} | V _{CC} = MAX, V _I = 0.5 V | | | -0.25 | | | -0.25 | mA |
| I _{OS} [§] | V _{CC} = MAX | -10 | | -100 | -10 | | -100 | mA |
| I _{CC} | V _{CC} = MAX | | 55 | 95 | | 55 | 80 | mA |

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MJW | | | JW OR NW | | | UNIT |
|--|-------------------------------------|-----|------------------|-----|----------|------------------|-----|------|
| | | MIN | TYP [‡] | MAX | MIN | TYP [‡] | MAX | |
| t _{a(A)} Access time from address | C _L = 30 pF | | 65 | 200 | | 65 | 110 | ns |
| t _{a(S)} Access time from chip select (enable time) | See Note 3 | | 40 | 125 | | 40 | 80 | ns |
| t _{dis} Disable time | C _L = 5 pF See Note 3 | | 25 | 100 | | 25 | 60 | ns |

[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25 °C.

[§]Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

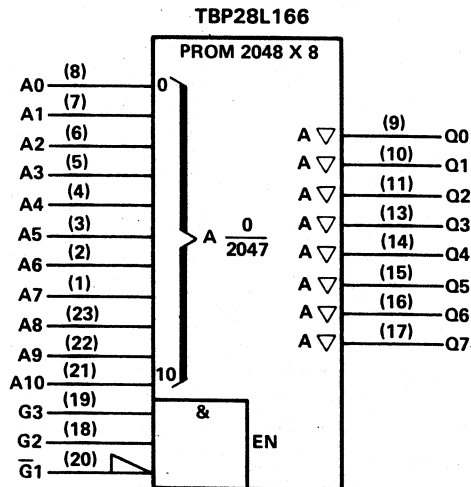
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

4

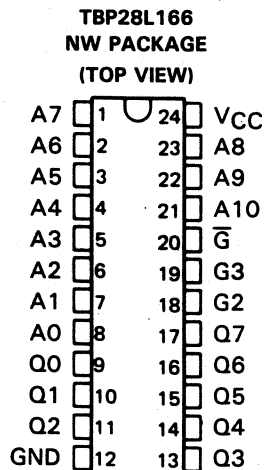
PROMS

TBP28L166
16,384 BITS (2084 WORDS BY 8 BITS)
LOW-POWER PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

logic symbol



pin assignment



recommended operating conditions

| PARAMETER | NW | | | UNIT |
|---|------|-----|------|------|
| | MIN | NOM | MAX | |
| V _{CC} Supply voltage | 4.75 | 5 | 5.25 | V |
| V _{IH} High-level input voltage | 2 | | | V |
| V _{IL} Low-level input voltage | | | 0.8 | V |
| I _{OH} High-level output current | | | -1.6 | mA |
| I _{OL} Low-level output current | | | 8 | mA |
| T _A Operating free-air temperature range | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | NW | | | UNIT |
|-------------------|---|-----|------|-------|------|
| | | MIN | TYP† | MAX | |
| V _{IK} | V _{CC} = 4.75, I _I = -18 mA | | | -1.2 | V |
| V _{OH} | V _{CC} = 4.75, I _{OH} = -1.6 mA | 2.4 | 3.1 | | V |
| V _{OL} | V _{CC} = 4.75, I _{OL} = 8 mA | | | 0.5 | V |
| I _{OZH} | V _{CC} = 5.25, V _O = 2.4 V | | | 50 | μA |
| I _{OZL} | V _{CC} = 5.25, V _O = 0.5 V | | | -50 | μA |
| I _I | V _{CC} = 5.25, V _I = 5.5 V | | | 1 | mA |
| I _{IH} | V _{CC} = 5.25, V _I = 2.7 V | | | 25 | μA |
| I _{IL} | V _{CC} = 5.25, V _I = 0.5 V | | | -0.25 | mA |
| I _{OS} ‡ | V _{CC} = 5.25 | -10 | | -100 | mA |
| I _{CC} | V _{CC} = 5.25 | | 75 | 110 | mA |

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | NW | | | UNIT |
|---|-------------------------------------|-----|------|-----|------|
| | | MIN | TYP† | MAX | |
| t _a (A) Access time from address | C _L = 30 pF | | 80 | 125 | ns |
| t _a (S) Access time from chip select (enable time) | See Note 3 | | 40 | 65 | ns |
| t _{dis} Disable time | C _L = 5 pF See Note 3 | | 30 | 65 | ns |

† All typical values are at V_{CC} = 5 V, T_A = 25 °C.

‡ Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

4

PROMS

SERIES 24 AND 28 PROGRAMMABLE READ-ONLY MEMORIES

recommended operating conditions for programming (see Figure 1)

| | | MIN | NOM | MAX | UNIT |
|---|--------------|-------|-----|-------|-------------|
| Steady-state supply voltage | V_{CC} | 4.75 | 5 | 5.25 | V |
| Input voltage | V_{IH} | 3 | 4 | 5 | V |
| | V_{IL} | 0 | 0 | 0.5 | |
| Voltage at all outputs except the one to be programmed | | 0 | 0 | 0.5 | V |
| Supply voltage level to program a bit | $V_{CC(pr)}$ | 5.75 | 6 | 6.25 | V |
| Select or enable level to program a bit | $V_{S(pr)}$ | 9.75 | 10 | 11 | V |
| Output level during interval t_5 | $V_{O(pr)}$ | 15.75 | 16 | 16.25 | V |
| Supply voltage during verification (see step 14) | Low | 4.4 | 4.5 | 4.6 | V |
| | High | 5.4 | 5.5 | 5.6 | |
| Time from V_{CC} to settle and to verify need to program | t_1 | 0 | 5 | 10 | μs |
| Time from $V_{CC} = 6 V$ until chip select (enable) is at 10 V- | t_2 | 5 | 5 | 10 | μs |
| Time from chip select (enable) high to start of program ramp | t_3 | 0.1 | 5 | 10 | μs |
| Ramp time, output program pulse | t_4 | 10 | 15 | 20 | μs |
| Duration of output program pulse | t_5 | 15 | 20 | 20 | μs |
| Time from end of program pulse to chip select (enable) low | t_6 | 5 | 5 | 10 | μs |
| Time from chip select (enable) $V_{CC} = 0 V$ | t_7 | 0.1 | 5 | 5 | μs |
| Time for cooling between bits | t_8 | 30 | 50 | 100 | μs |
| Time for cooling between words | t_9 | 30 | 50 | | μs |
| Free-air temperature | T_A | 20 | 25 | 30 | $^{\circ}C$ |

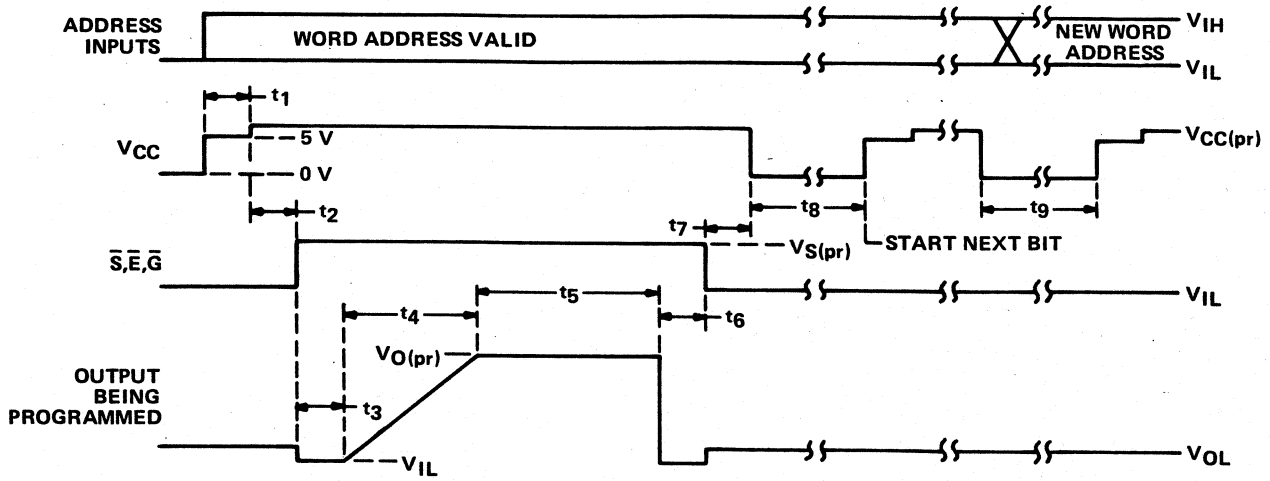
step-by-step programming instruction (see Figure 1)

1. Address the word to be programmed, apply 5 volts to V_{CC} and active levels to all chip select (S and \bar{S}) or chip enable (E and \bar{E}) inputs.
2. Verify the status of a bit location by checking the output level.
3. Decrease V_{CC} to 0 volts.
4. For bit locations that do not require programming, skip steps 5 through 11.
5. Increase V_{CC} to $V_{CC(pr)}$ with a minimum current capability of 250 milliamperes.
6. Apply $V_{S(pr)}$ to all the \bar{S} , \bar{E} or \bar{G} inputs. $I_l \leq 25$ milliamperes. Active-high enables may be left high.
7. Connect all outputs, except the one to be programmed, to V_{IL} . Only one bit is to be programmed at a time.
8. Apply the output programming pulse for 20 microseconds. Minimum current capability of the programming supply should be 250 milliamperes.
9. After terminating the output pulse, disconnect all outputs from V_{IL} conditions.
10. Reduce the voltage at \bar{S} , \bar{E} , or \bar{G} inputs to V_{IL} .
11. Decrease V_{CC} to 0 volts.
12. Return to step 4 until all outputs in the word have been programmed.
13. Repeat steps 2 through 11 for each word in memory.
14. Verify programming of every word after all words have been programmed using V_{CC} values of 4.5 and 5.5 volts.

4

PROMS

**SERIES 24 AND 28
PROGRAMMABLE READ-ONLY MEMORIES**



NOTE 4: Rise and fall times should be $\leq 1 \mu s$.

FIGURE 1. TIMING DIAGRAM AND VOLTAGE WAVEFORMS FOR PROGRAMMING SEQUENCE

IMPORTANT NOTICE

Texas Instruments (TI) reserves the right to make changes to its products or to discontinue any semiconductor product or service without notice, and advises its customers to obtain the latest version of relevant information to verify, before placing orders, that the information being relied on is current and complete.

TI warrants performance of its semiconductor products and related software to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

Certain applications using semiconductor products may involve potential risks of death, personal injury, or severe property or environmental damage ("Critical Applications").

TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, INTENDED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT APPLICATIONS, DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS.

Inclusion of TI products in such applications is understood to be fully at the risk of the customer. Use of TI products in such applications requires the written approval of an appropriate TI officer. Questions concerning potential risk applications should be directed to TI through a local SC sales office.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards should be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein. Nor does TI warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used.